

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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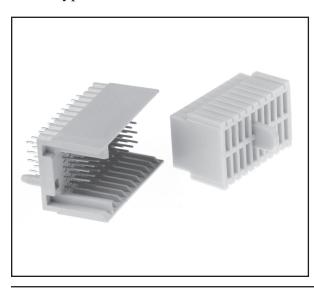




3M[™] MetPak[™] HM Header

2 mm Type CL, 55/77 Contacts, 5 Rows, Straight

HM Series



- Modular/scalable format IEC 61076-4-101
- Press-fit or solder tail version
- 63 mated lines per linear inch
- Ships with protective cap, which also serves as an insertion tool
- End-to-end stackable with 5 row 3M[™] MetPak[™] CP2, HM and HSHM products
- See the Regulatory Information Appendix (RIA) in the "RoHS compliance" section of www.3M.com/Interconnect for compliance information (RIA E1 & C1 apply)

Date Modified: November 17, 2010

TS-2007-C Sheet 1 of 3

Physical

Insulation:

Material: High Temperature Thermoplastic (LCP)

Flammability: UL 94V-0

Contact:

Material: Copper Alloy

Plating: See Ordering Information

Marking: 3M Logo, Part Number, Revision, Date Code

Performance

Mechanical:

Normal Force (Nominal): 0.57 N [58 g] Signal
Engagement Force (Nominal): 0.32 N [33 g] Signal
Separation Force (Nominal): 0.20 N [20 g] Signal
Wipe (Nominal, Shortest Contact): 2.67 mm [0.105 in] Signal

Mate/Unmate Cycles: 250

Application: This module is not suitable for stand-alone use. (Refer to IEC-61076-4-101)

Electrical:

Current Rating (Fully Loaded): $1 \text{ A} @ 70^{\circ} \text{ C}$ Signal Insulation Resistance: $1 \text{ x } 10^{4} \text{ M}\Omega @ 100 \text{ V}_{DC}$

Withstanding Voltage: 750 V_{RMS}

Environmental

Temperature Rating: -55° C to 125° C

Process Rating: Maximum 260°C (per J-STD-020C)

Moisture Sensitivity Level: 1 (per J-STD-020C)

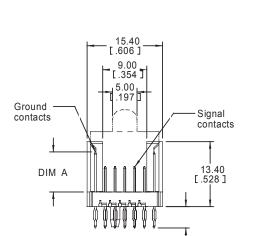
UL File No.: E68080 Metpak is a trademark of 3M Company.

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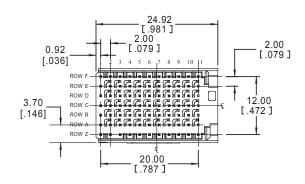


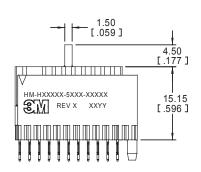


[] Dimensions for Reference Only



DIM A = Pin mating length DIM B = Pin tail length





This view shown with protective cap*

* Cap to be removed after press-fit installation process

Ordering Information

HM - H055CL1 - 5CX1 - XXXXX (rows F and Z not loaded)

DIM B

HM - H077CL2 - 5BX1 - XXXXX (rows F and Z loaded 8.3 mm mate length)

Tail Style: P = Press-fit tail S = Solder tail

Plating µm [µ"]: TG30 = 0.76 [30] Min. Au Contact Area

2.54 [100] Min. SnPb Terminal Area (RIA C2 & E2 apply)

1.27 [50] Min. Ni All over Standard Option

TG30L = 0.76 [30] Min. Au Contact Area, Lubricated

2.54 [100] Min. SnPb Terminal Area (RIA C2 & E2 apply)

1.27 [50] Min. Ni All over

Typically higher make order quantities as compared to TG30.

TG50 = 1.27 [50] Min. Au Contact Area, Lubricated

2.54 [100] Min. SnPb Terminal Area (RIA C2 & E2 apply) 1.27 [50] Min. Ni All over

Non-Standard Option (Available with longer lead times and higher make order quantities, MOQ)

> TS-2007-C Sheet 2 of 3

Standard configuration

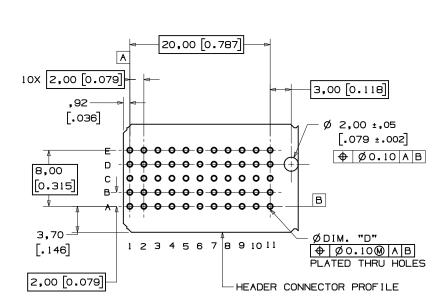
representative.

DIM B = 4.4 mm

DIM A = 5.3 mm for rows A through E

For non-standard configurations contact sales

2 mm Type CL, 55/77 Contacts, 5 Rows, Straight



RECOMMENDED PCB HOLE PATTERN

HOLE PLATING SPECIFICATION				
HOLE	Finished Dia. mm [in]	Cu Thickness	SnPb Thickness microns [µ"]	Drilled Hole Dia. mm [in]
"D"	0.550–0.650 [.0217–.0256]	0.025-0.045 [.00100018]	0.008-0.018 [.00030007]	0.686-0.727 [.02700286]

TS-2007-C Sheet 3 of 3

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